



LTE IoT Breakout Carrier

Revision A

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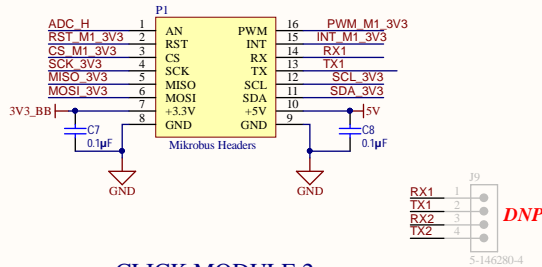
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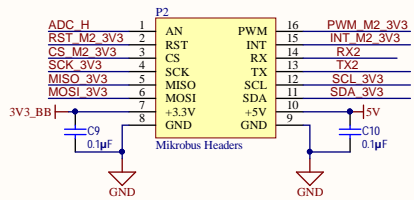
Note?

AVNET Avnet Engineering Services			
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Doc Num:	SCH-BO2CAR		Date: 7/17/2017 Time: 12:11:42 PM
Sheet Title:	01 - Avnet Lead Sheet.SchDoc		Size: B Sheet: 1 of 3

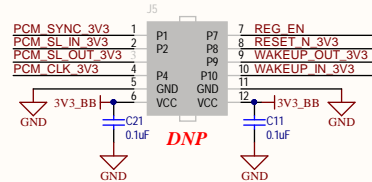
CLICK MODULE 1



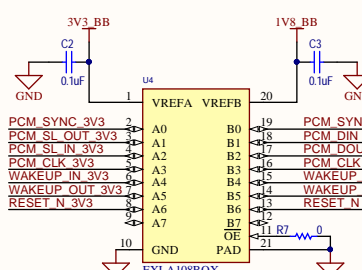
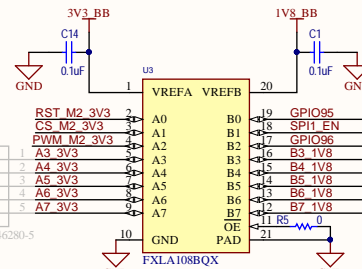
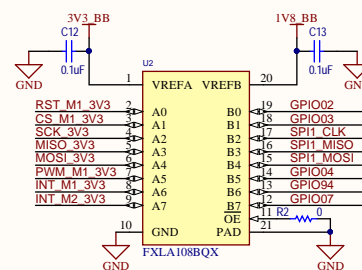
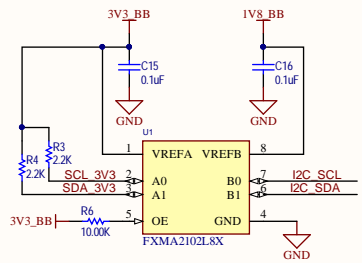
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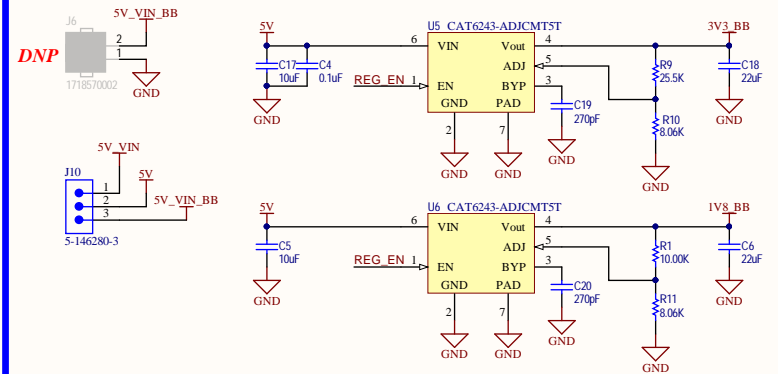
PMOD



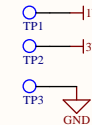
VOLTAGE LEVEL TRANSLATORS



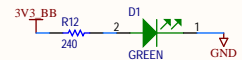
POWER



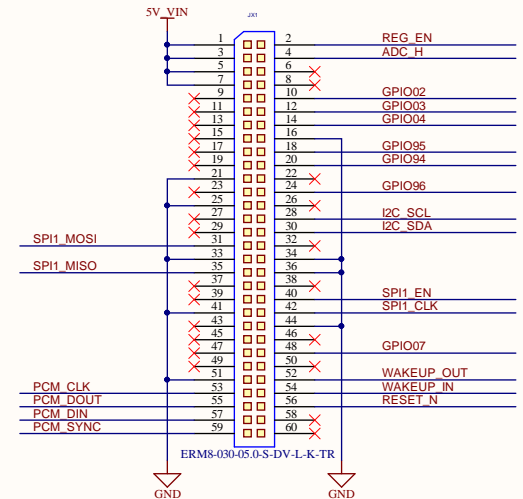
TEST POINTS



POWER READY LED



60 PIN HEADER



Assembly: Mechanicals:

Label1
R01-XXXX-XXXXX.C
Label, Product



PCB

XXX-XXX-PCB-X

PCB PN (In Copper)



BUMPER CYLINDRICAL 0.25" DIA CLR



ESD Bag

Label_ESD1



Label, ESD

J1
Mikrobus 8-Pin
PPTC08ILFBN-RC (Place holder)

J2
Mikrobus 8-Pin
PPTC08ILFBN-RC (Place holder)

J3
Mikrobus 8-Pin
PPTC08ILFBN-RC (Place holder)

J4
Mikrobus 8-Pin
PPTC08ILFBN-RC (Place holder)

SH1



SHUNT, ECON, PHBR 15 AU.BLACK

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Project Name: LTE IoT Breakout Carrier		PCB Rev: A	BOM: 01
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